### 506545127 03/09/2021

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6591906

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

#### **CONVEYING PARTY DATA**

Name	Execution Date
NIKHIL VERMA	02/23/2021
VISHNU VARDHAN KASILYA SUDARSAN	02/25/2021
NAGA CHANDAN BABU GUDIVADA	02/23/2021
DARSHANA PARMANAND HOTKAR	02/25/2021
BALAMUKUND SRIPADA	02/23/2021

#### **RECEIVING PARTY DATA**

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17179822

### **CORRESPONDENCE DATA**

**Fax Number:** (651)735-1102

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 6517351100

**Email:** pairdocketing@ssiplaw.com **Correspondent Name:** SHUMAKER & SIEFFERT, P.A.

Address Line 1: 1625 RADIO DRIVE

Address Line 2: SUITE 100

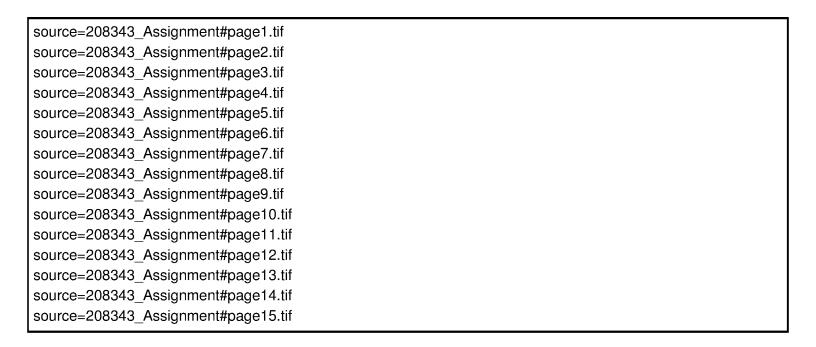
Address Line 4: WOODBURY, MINNESOTA 55125

ATTORNEY DOCKET NUMBER:	1616-092US01
NAME OF SUBMITTER:	SUSAN J. DALY
SIGNATURE:	/Susan J. Daly/
DATE SIGNED:	03/09/2021
	•

**Total Attachments: 15** 

PATENT REEL: 055539 FRAME: 0007

506545127



WHEREAS, WE,

- 1. **Nikhil VERMA**, having a mailing address located at 5775 **Morehouse Drive, San Diego, CA 92121-1714**,
- 2. Vishnu Vardhan KASILYA SUDARSAN, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
- 3. **Naga Chandan Babu GUDIVADA**, having a mailing address located at 5775 **Morehouse Drive, San Diego, CA 92121-1714**,
- 4. **Darshana Parmanand HOTKAR**, having a mailing address located at 5775 **Morehouse Drive, San Diego, CA 92121-1714**,
- 5. Balamukund SRIPADA, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **UNDER-DISPLAY CAMERA SYSTEMS AND METHODS** (collectively the "**INVENTIONS**") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 17/179,822, filed February 19, 2021, Qualcomm Reference Number 208343, and all provisional applications relating thereto (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

## PATENT

Qualcomm Reference Number: 208343

Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	Bung leve Kurrilah City, State, Country	vana , on <u>23-feb</u>	- 2021 Date	Mikhil VERMA
Done at	City, State, Country	, on	Date	Vishnu Vardhan KASILYA SUDARSAN
Done at	City, State, Country	, on	Date	Naga Chandan Babu GUDIVADA
Done at	City, State, Country	, on	Date	Darshana Parmanand HOTKAR
Done at	City, State, Country	, on	Date	Balamukund SRIPADA

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WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

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AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

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	Davidson Parameter (1977)

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# PATENT

Qualcomin Reference Somber 208343 Fags 3 of 3

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Done at	.on		
	City, State, Country	Date	Nikhil VERMA
Done at	, on		Vishnu Vardhan KASILYA SUDARSAN
	City, State, Country	Date	Vishnu Vardhan KASILYA SUDARSAN
Done at	Hydrophad, India	na 23-Feb-2021	G.N.C.B. A
	City, State, Country	Date	Naga Chandan Babu GUDIVADA
Done at	City, State, Country	Date	Darshana Parmanand HOTKAR
Done at	. on		
	City, State, Country, on	Date	Balamukund SRIPADA

**PATENT** 

REEL: 055539 FRAME: 0017

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AND WE REPER coverant that WE will not execute any writing or do any acwholsoever conflicting with these presents

	City State Country	-	Date	Darshana Farmanand (1973), 83
None	HYDERABAD TELENGANA	<sub>31</sub> 25/02	/2021	Darshana Parmanaud HOTICAR
Donest	Car State Country	, tri	Date	Naga Chandan Babu GUDIV 4394
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Description	City State County		i i	Name of the Control o

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PATENT Outdoord Religious Francis 208543 Francis et al.

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Done at	HYDE RABAD. Car State Country	90 A on 22 local	2 <i>02]</i> Date	Balancia SRIPADA
	City, State, Country			Darshana Parmanand HOTKAR
Done at	City, State, Country	on	Dere	Naga Chandan Babu GUDIVADA
Dencar	Cate State Country	CRI	Date	Vishoo Vardhao KASII VA SUDARSA:
Descrip	City, State, Country	, 08	Date	Nichil VERMA

PATENT REEL: 055539 FRAME: 0023

RECORDED: 03/09/2021